Technical Information Bulletin

CuLox Coarse—6200, 6300 Powders



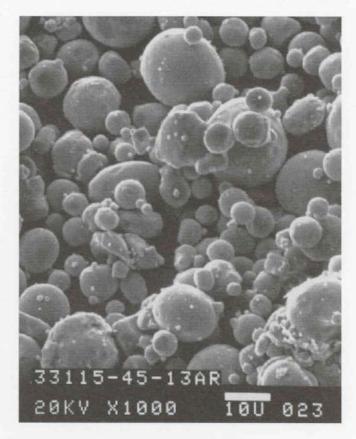
Description

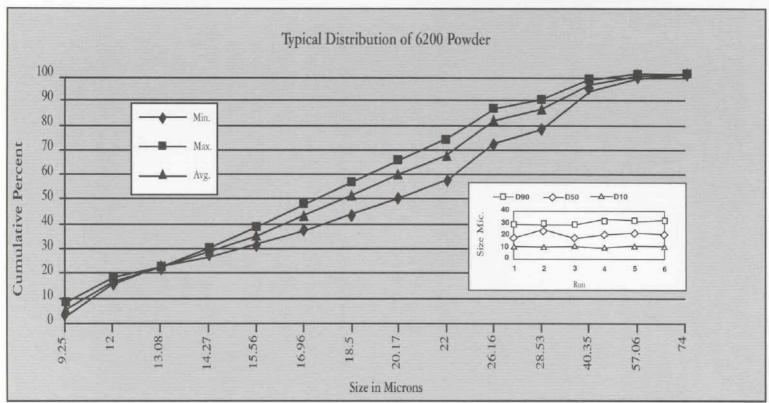
High purity, high density gas atomized powder made principally for the electronic industry in the manufacture of printed circuit boards and other uses.

General Application

CuLox powders are developed for use in the manufacture of electronic pastes, EMI shielding, EDM electrodes, etc. They are also used in thermal spraying applications.

Physical Properties	6200	6300
Particle Shape	Sphere	Sphere
Med. Size (Microtrac), Mic.	17-35	25-35
Surface Area (m2/g)	< 0.30	< 0.20
Tap Density (gm/cc)	> 3.75	> 3.75





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